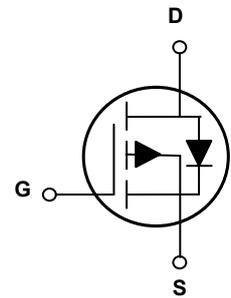
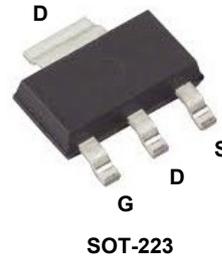


## Main Product Characteristics

$BV_{DSS}$	-100V
$R_{DS(ON)}$	200m $\Omega$
$I_D$	-2A



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSFL1003 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

## Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	$V_{DS}$	-100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous ( $T_A=25^\circ\text{C}$ )	$I_D$	-2	A
Drain Current-Continuous ( $T_A=70^\circ\text{C}$ )		-1.6	
Drain Current-Pulsed <sup>1</sup>	$I_{DM}$	-8	A
Single Pulse Avalanche Energy <sup>2</sup>	$E_{AS}$	24	mJ
Single Pulse Avalanche Current <sup>2</sup>	$I_{AS}$	22	A
Power Dissipation ( $T_A=25^\circ\text{C}$ )	$P_D$	1.78	W
Power Dissipation - Derate above $25^\circ\text{C}$		0.014	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	70	$^\circ\text{C}/\text{W}$
Operating Junction Temperature Range	$T_J$	-55 To +150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 To +150	$^\circ\text{C}$

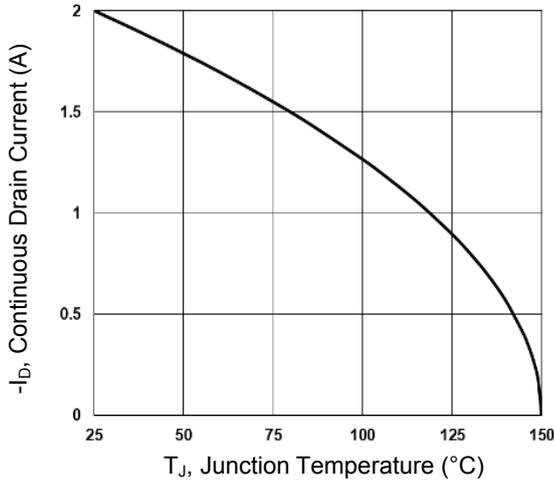
**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>On / Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-100	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=-100V, V_{GS}=0V, T_J=25^\circ\text{C}$	-	-	-1	$\mu A$
		$V_{DS}=-80V, V_{GS}=0V, T_J=125^\circ\text{C}$	-	-	-10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-2A$	-	165	200	m $\Omega$
		$V_{GS}=-4.5V, I_D=-1.5A$	-	180	230	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-1.2	-1.6	-2.2	V
Forward Transconductance	$g_{fs}$	$V_{DS}=-10V, I_D=-1.5A$	-	6.5	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>3,4</sup>	$Q_g$	$V_{DS}=-50V, I_D=-1A, V_{GS}=-10V$	-	20	30	nC
Gate-Source Charge <sup>3,4</sup>	$Q_{gs}$		-	2.4	5	
Gate-Drain Charge <sup>3,4</sup>	$Q_{gd}$		-	3.3	7	
Turn-On Delay Time <sup>3,4</sup>	$t_{d(on)}$	$V_{DD}=-50V, R_G=6\Omega, V_{GS}=-10V, I_D=-1A$	-	18	27	nS
Rise Time <sup>3,4</sup>	$t_r$		-	8	12	
Turn-Off Delay Time <sup>3,4</sup>	$t_{d(off)}$		-	100	150	
Fall Time <sup>3,4</sup>	$t_f$		-	30	45	
Input Capacitance	$C_{iss}$	$V_{DS}=-50V, V_{GS}=0V, F=1\text{MHz}$	-	1280	2000	pF
Output Capacitance	$C_{oss}$		-	55	100	
Reverse Transfer Capacitance	$C_{rss}$		-	30	60	
Gate Resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	-	16	-	$\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_S$	$V_G=V_D=0V, \text{Force Current}$	-	-	-2	A
Pulsed Source Current	$I_{SM}$		-	-	-4	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=-1A, T_J=25^\circ\text{C}$	-	-	-1	V
Reverse Recovery Time	$t_{rr}$	$V_R=-100V, I_S=-1A, di/dt=100A/\mu s, T_J=25^\circ\text{C}$	-	35	-	nS
Reverse Recovery Charge	$Q_{rr}$		-	30	-	nC

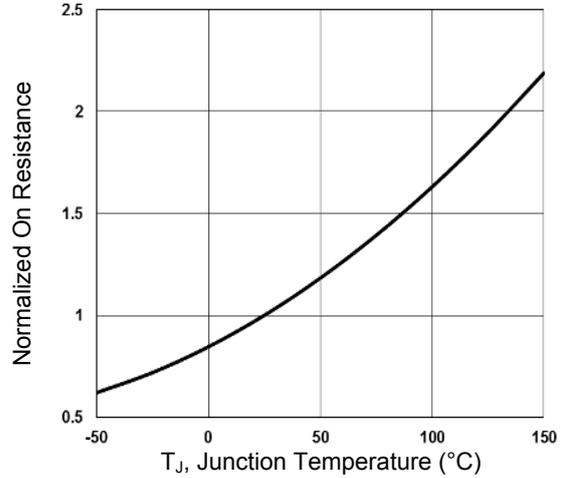
Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=22A, \text{starting } T_J=25^\circ\text{C}$ .
3. Pulse test: pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

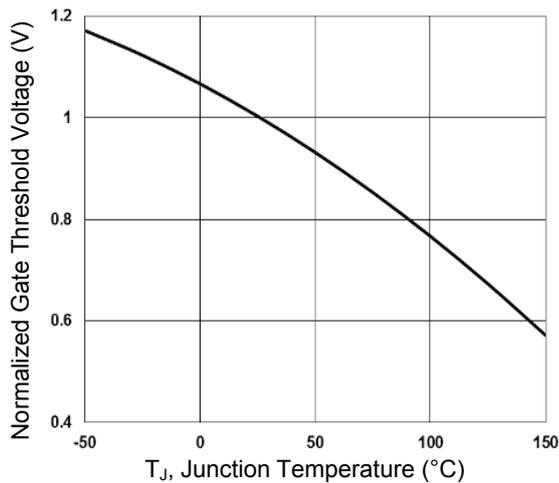
**Typical Electrical and Thermal Characteristic Curves**



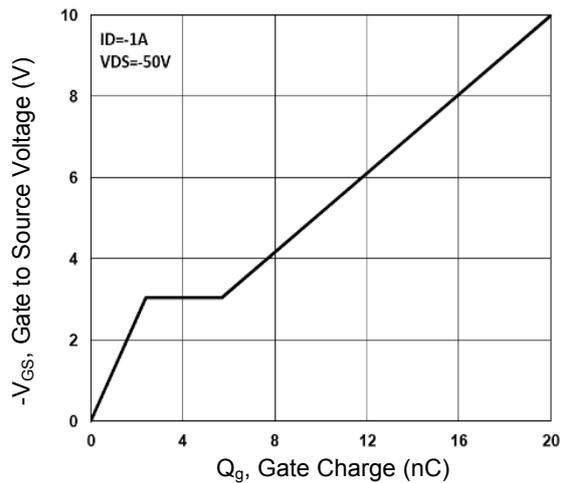
**Figure 1. Continuous Drain Current vs.  $T_J$**



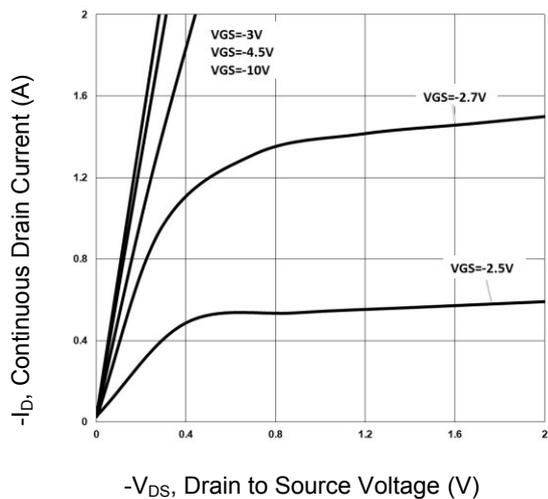
**Figure 2. Normalized  $R_{DS(ON)}$  vs.  $T_J$**



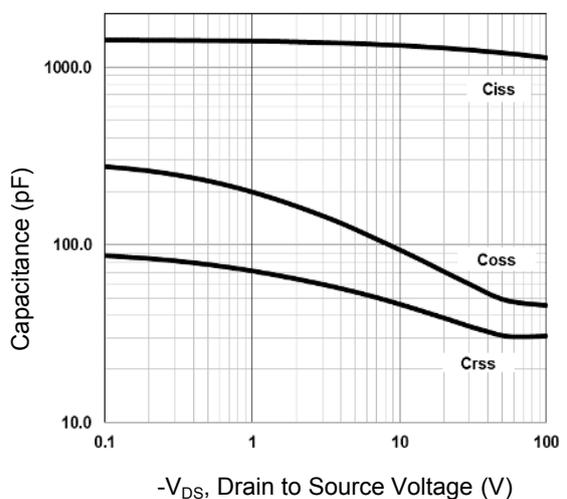
**Figure 3. Normalized  $V_{th}$  vs.  $T_J$**



**Figure 4. Gate Charge Characteristics**

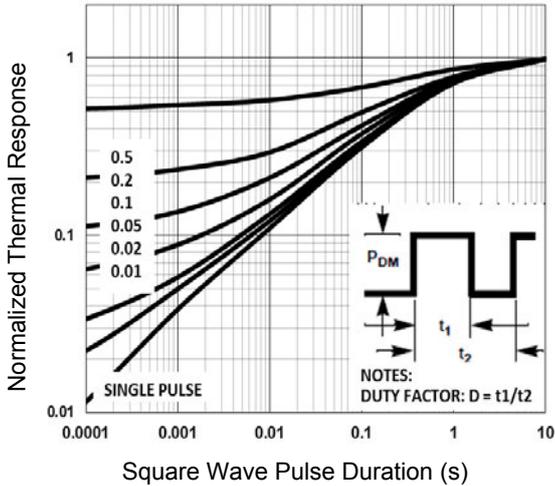


**Figure 5. Typical Output Characteristics**

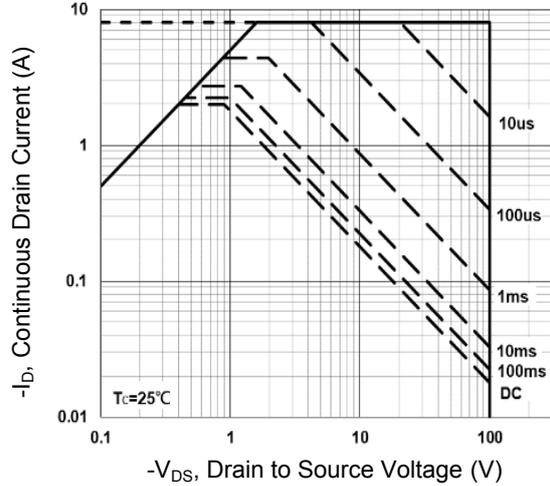


**Figure 6. Capacitance Characteristics**

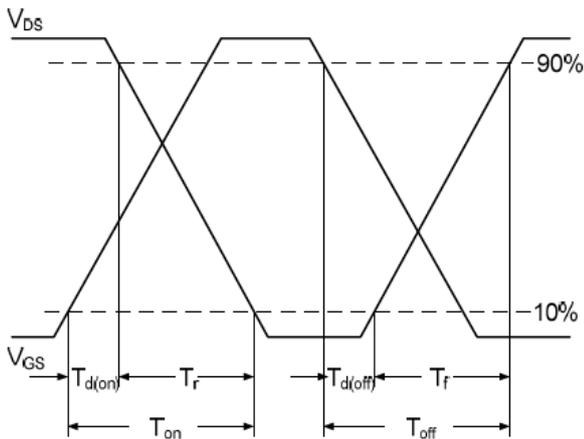
**Typical Electrical and Thermal Characteristic Curves**



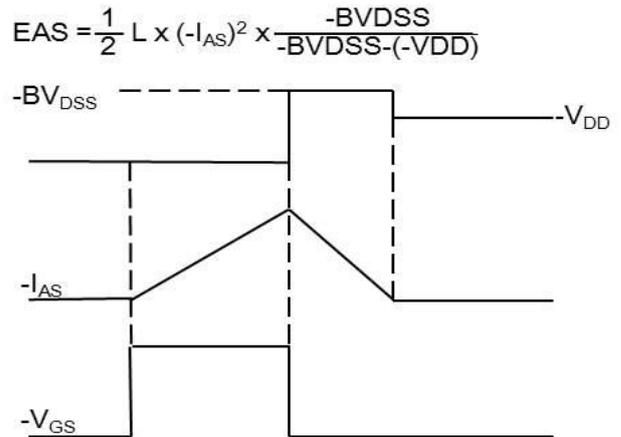
**Figure 7. Normalized Transient Impedance**



**Figure 8. Maximum Safe Operation Area**

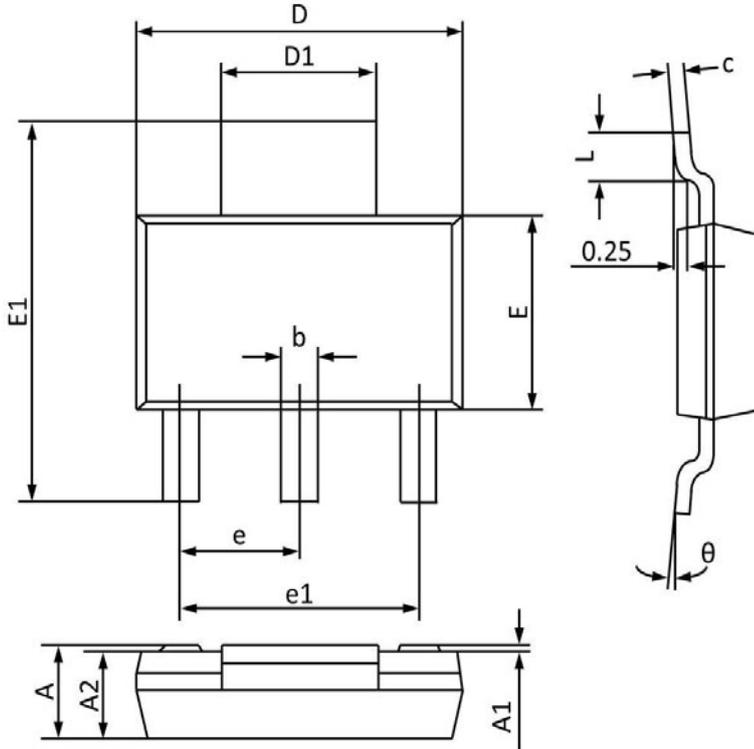


**Figure 9. Switching Time Waveform**



**Figure 10. EAS Waveform**

**Package Outline Dimensions SOT-223**



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	1.500	1.800	0.060	0.071
A1	0.000	0.120	0.000	0.005
A2	1.450	1.750	0.057	0.069
b	0.600	0.820	0.024	0.032
c	0.200	0.350	0.008	0.014
D	6.200	6.700	0.244	0.264
D1	2.900	3.100	0.114	0.122
E	3.300	3.700	0.130	0.146
E1	6.700	7.300	0.264	0.287
e	2.30 BSC		0.091 BSC	
e1	4.400	4.700	0.173	0.185
L	0.900	1.150	0.035	0.045
θ	0°	10°	0°	10°